# ESTIMATION OF EXCITATION DENSTITY OF REPORTED TWO-PHOTON PHOTOLUMINESCENCE INTENSITY DISTRIBUTIONS AT A DISLOCATION IN AN n-GaN LAYER ON A M-3D SUBSTRATE

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We estimated the excitation density of the reported two-photon photoluminescence from an n-GaN layer on an M-3D substrate by fitting the intensity distributions at a dislocation. We found that all the data points of the intensity distributions were reproduced with the effective dislocation radius of 8 nm. Considering the range of the excess hole concentration ( $\Delta p$ ) within which almost all data points fell, we estimated  $\Delta p$  to be  $10^{16\pm1}$  cm<sup>-3</sup>.

### I. Introduction

Development of high-quality GaN substrates has made it possible to easily fabricate vertical p<sup>+</sup>n diodes on free-standing substrates. A record high breakdown voltage of 5 kV has been achieved in combination with a low on-resistance  $R_{on}$  of 1.25 m $\Omega$  cm<sup>2</sup> at a forward voltage of 5 V.<sup>1</sup>) The quality of substrates has also been improved. For example, low-dislocation-density ( $N_{dis} \le 4 \times 10^5$  cm<sup>-2</sup>) GaN substrates became available via hydride vapor phase epitaxy (HVPE) and a maskless 3D (M-3D) method.<sup>2</sup>) To suppress propagation of dislocations from the seed crystal, the M-3D method avoids *c*-plane growth; namely, the initial three-dimensional growth is followed by two-dimensional growth in which growth temperature and partial pressures of gallium chloride and ammonia are changed.<sup>2</sup>)

On M-3D substrates, as well as on conventional substrates by the void-assisted separation (VAS) method,<sup>3)</sup> Ohta et al. fabricated GaN p<sup>+</sup>n diodes and observed a positive correlation between  $R_{on}$  and  $N_{dis}$ .<sup>4)</sup> They also observed two-photon photoluminescence (2PPL) from an 8-µm-thick n-GaN (donor density  $N_D$ :  $1 \times 10^{16}$  cm<sup>-3</sup>) layer on an M-3D substrate and identified dislocations as dark spots.<sup>4-7)</sup> The ambipolar lifetime  $\tau_a$  determined by 2PPL, however, depends on the excitation density, which was not clear with respect to their 2PPL measurement. Accordingly, in this paper, we estimate  $\tau_a$  and the excess hole concentration ( $\Delta p$ ) in the 2PPL measurement reported in Ref. 4.

### **II.** Analysis

The diffusion and recombination of electrons and holes generated by the source  $Q(\mathbf{r})$  are described by the following three-dimensional equation

$$D_{a} \Delta n(\mathbf{r}) - n(\mathbf{r}) / \tau_{a} + Q(\mathbf{r}) = 0, \qquad (1)$$

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where  $D_a$  is the ambipolar diffusivity.  $\tau_a$  is expressed from charge neutrality as

$$\tau_{a} = \tau_{po} \left[ 1 + \{ \Delta p / (N_{D} + \Delta p) \} \right], \tag{2}$$

where  $\tau_{po}$  is the hole lifetime under low-injection conditions. Based on anode-radiusdependent forward current/voltage characteristics of GaN p<sup>+</sup>n diodes on an M-3D substrate, Mochizuki et al. extracted Shockley–Read–Hall lifetime  $\tau_{SRH}$  of 11 ns.<sup>8)</sup>  $\tau_{SRH}$  is expressed as

$$\tau_{\rm SRH} = (\tau_{\rm no} \, \tau_{\rm po})^{0.5},\tag{3}$$

where  $\tau_{no}$  is the electron lifetime under low-injection conditions. Here  $\tau_{po}$  and  $\tau_{no}$  are given as

$$\tau_{\rm po} = (N_{\rm t} \, v_{\rm thp} \, \sigma_{\rm p})^{-1}, \tag{4}$$

$$\tau_{\rm no} = (N_{\rm t} \, v_{\rm thn} \, \sigma_{\rm n})^{-1}, \tag{5}$$

where  $N_t$  is the concentration of a non-radiative recombination center,  $v_{thp}$  and  $\sigma_p$  are, respectively, the thermal velocity and capture cross section of holes, and  $v_{thn}$  and  $\sigma_n$  are, respectively, the thermal velocity and capture cross section of electrons. At 300 K,  $\sigma_p$ ,  $\sigma_n$ ,  $v_{thp}$ , and  $v_{thn}$ , were reported, by Chichibu et al.,<sup>9)</sup> Maeda et al.,<sup>10)</sup> and Saini et al.,<sup>11)</sup> to be  $7 \times 10^{-14}$  cm<sup>2</sup>,  $3 \times 10^{-13}$  cm<sup>2</sup>,  $2.38 \times 10^7$  cm s<sup>-1</sup>, and  $2.43 \times 10^7$  cm s<sup>-1</sup>, respectively. Putting these values into Eqs. (3)–(5) results in the following relation:

$$\tau_{\rm SRH} = 0.48 \, \tau_{\rm po.}$$
 (6)

The influence of surface recombination can be ignored because the excitation energy in 2PPL is smaller than the bandgap of n-GaN.<sup>12)</sup> The flux to the cylindrical surface of a dislocation can thus be simply calculated. When the carrier-recombination velocity at a dislocation with the effective radius R is S, the normalized photoluminescence intensity at a distance r from a dislocation, I(r), is expressed as<sup>13)</sup>

$$I(r) = 1 - K_0 (r/(D_a \tau_a)^{0.5}) / [K_0 (R/(D_a \tau_a)^{0.5} + (D_a/RS)],$$
(7)

$$D_{\rm a} = [N_{\rm D} + \Delta p + (n_{\rm i}^2/N_{\rm D}) + \Delta p] D_{\rm e}D_{\rm h} / \{D_{\rm e}(N_{\rm D} + \Delta p) + D_{\rm h} [(n_{\rm i}^2/N_{\rm D}) + \Delta p]\},$$
(8)

where  $K_0$  is the zeroth order modified Bessel function of second kind,  $n_i$  is the intrinsic carrier concentration,  $D_e$  is the electron diffusivity, and  $D_h$  is the hole diffusivity.  $D_h$  was reported to be anisotropic; namely, a ratio of 1.17 for diffusivity perpendicular and parallel to the c-axis.<sup>14)</sup> Hall measurement of a *c*-plane GaN layer is thus suited for determining diffusivity perpendicular to the *c*-axis. We carried out Hall measurement of a  $1 \times 10^{18}$  cm<sup>-3</sup> doped p-GaN layer on an M-3D (0001) substrate and found that the majority hole mobility  $\mu_h$  was 29 cm<sup>2</sup>V<sup>-1</sup>s<sup>-1</sup>. Since  $\mu_h$  is typically constant at [Mg] <  $1 \times 10^{18}$  cm<sup>-3 15)</sup> and the minority hole mobility was reported to agree with  $\mu_{h,}^{16)} D_h$  was calculated from the Einstein relation to be 0.75 cm<sup>2</sup>s<sup>-1</sup> at 300 K. With respect to *S*, a constant value was assumed by Conolato in their dislocation model of semiconductors.<sup>17)</sup> Although this is the case under low excitation conditions, modeling *S* is complex under high excitation conditions. Here we simply assume *S* to be as large as the thermal velocities of carriers.<sup>11)</sup>

 $\tau_a$  and  $D_a$  saturate when  $\Delta p$  is less than  $10^{13}$  cm<sup>-3</sup> or larger than  $10^{19}$  cm<sup>-3</sup>. As shown in Figs. 1(a) and 1(c), some data points are not within  $\Delta p = 10^{16\pm3}$  cm<sup>-3</sup> under the assumption of R = 6 or 10 nm. In contrast, all data points fall within  $\Delta p = 10^{16\pm3}$  cm<sup>-3</sup> when we assume R of 8 nm [Fig. 1(b)]. Considering the  $\Delta p$  range within which almost all data points fall, we estimated  $\Delta p$  being  $10^{16\pm1}$  cm<sup>-3</sup>.

# **III.** Conclusions

Bv fitting intensity the distributions at a dislocation in an n-GaN layer on an M-3D substrate, we estimated the excess hole concentration during reported two-photon the photoluminescence measurement to be  $10^{16\pm1}$  cm<sup>-3</sup>.

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Fig. 1. Measured (symbols)<sup>4)</sup> and fitted (lines) distributions of 2PPL intensity at a dislocation in an n-GaN layer on an M-3D substrate. R: effective dislocation radius;  $\Delta p$ : excess hole concentration.

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